

Model Name: P320HVN02.0

Issue Date: 2018/03/29

()Preliminary Specifications (*)Final Specifications

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Record of Revision

Version	Date	Page	Description				
0.0	2014/04/17		1st release				
6,9,21			Correct the model name to P320HVN02.0				
1.0	2014/05/05	23	Modify the 2D drawing (location of LVDS connector)				
2.0	2014/09/25		Modify to PID new template				
		20	Change optical specification: surface luminance, color coordinates				
3.0	2015/03/18	24~26	pdate 2D drawing				
3.0	2015/03/16	27	Add packing reliability test				
		31	Modify Pallet and Shipment Information				
4.0	2015/04/14	7	Correct test condition Fv to 60Hz				
4.0	2015/04/14	17	Modify backlight electrical specification				
		10	LCD connector: FI-RTE51SZ-HF (JAE, LVDS connector) or compatible				
		16	t10 & t11 are removed and t8 corrected to 20				
5.0	2015/04/22	18	LED driver board connector: Cvilux CI0114M1HRL-NH or equivalent				
		10	PDIM value is corrected to 5~100%				
		19	Remove "V_IPWM" in diagram				
	F	1	Adding pin definition remark:				
6.0	2018/03/29	11~13 35	Note: No contract during host and an an interview graph. Note: Name was in C. processories at any six speed (as of Conting). Note: Name was in C. processories at any six speed (as of Conting). Note: Name was in C. processories at any speed (as of Conting). Note: Name was in C. processories at any speed (as of Conting). Note: Name was in C. processories at any speed (as of Conting). Note: Name was in Conting was in C. processories at any speed (as of Conting). Note: Observed Conting. Note: Observed Conting.				
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			- Oliver 1 2 08:3				



1. General Description

This specification applies to the 31.5 inch Color TFT-LCD Module P320VN02.0. This LCD module has a TFT active matrix type liquid crystal panel 1920x1080 pixels, and diagonal size of 31.5 inch. This module supports 1920x1080 mode. Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the brightness of the sub-pixel color is determined with a 8-bit gray scale signal for each dot.

The P320HVN02.0 has been designed to apply the 8-bit 2 channel LVDS interface method. It is intended to support displays where high brightness, wide viewing angle.

* General Information

Items	Specification	Unit	Note	
Active Screen Size	31.5	inch		
Display Area	698.4 (H) x 392.85(V)	mm		
Outline Dimension	719.2(H) x 413.7(V) x 24.8(D)	mm	D: Max.	
Driver Element	a-Si TFT active matrix			
Bezel Opening	703.4(H) x 397.9(V)	mm		
Display Colors	8 bits	Colors		
Number of Pixels	1,920x1,080	Pixel		
Pixel Pitch	0.3637 (H) x 0.3637 (W)	mm		
Pixel Arrangement	RGB vertical stripe			
Display Operation Mode	Normally Black		101	
Surface Treatment	Anti-Glare, 3H		Haze=2%	
Rotate Function	Unachievable	1150	Note 1	
Display Orientation	Portrait/Landscape Enabled		Note 2	

Note 1: Rotate Function refers to LCD display could be able to rotate. This function does not work in this model.

Note 2: Please refer to 5.1 Placement Suggestions.



2. Absolute Maximum Ratings

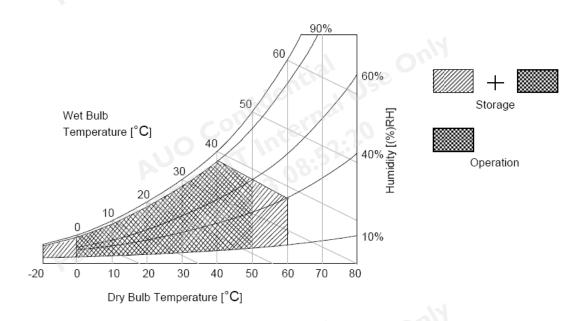
The followings are maximum values which, if exceeded, may cause faulty operation or damage to the unit

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vcc	-0.3	14	[Volt]	Note 1
Input Voltage of Signal	Vin	-0.3	4	[Volt]	Note 1
Operating Temperature	TOP	0	+50	[°C]	Note 2
Operating Humidity	HOP	10	90	[%RH]	Note 2
Storage Temperature	TST	-20	+60	[°C]	Note 2
Storage Humidity	HST	10	90	[%RH]	Note 2
Panel Surface Temperature	PST		65	[°C]	Note 3

Note 2 : Maximum Wet-Bulb should be 39°C and No condensation.

The relative humidity must not exceed 000′ The relative humidity must not exceed 90% non-condensing at temperatures of 40°C or less. At temperatures greater than 40°C, the wet bulb temperature must not exceed 39°C

Note 3: Surface temperature is measured at 50°C Dry condition





3. Electrical Specification

The P320HVN02.0 requires two power inputs. One is employed to power the LCD electronics and to drive the TFT array and liquid crystal. The other is to power Back Light Unit.

3.1 Electrical Characteristics

3.1.1 DC Characteristics (Ta = 25 \pm 2 °C)

	Davamatas Charles	Current of		Value	- Unit	Note	
	Parameter	Symbol	Min.	Тур.	Max	Unit	Note
LCD	7						
Power Sup	oply Input Voltage	V_{DD}	10.8	12	13.2	V _{DC}	
Power Sup	oply Input Current	I _{DD}		0.39	0.56	А	1
Power Cor	nsumption	Pc	C10-	4.68	7.39	Watt	1
Inrush Cur	rent	I _{RUSH}	-03/		5	А	2
Permissibl	e Ripple of Power Supply Input Voltage	V _{RP}	0	0	V _{DD} * 5%	mV _{pk-pk}	3
	Input Differential Voltage	V _{ID}	200	400	600	mV _{DC}	4
LVDS	Differential Input High Threshold Voltage	Vтн	+100		+300	mV _{DC}	4
Interface	Differential Input Low Threshold Voltage	V _{TL}	-300		-100	mV _{DC}	4
	Input Common Mode Voltage	V _{ICM}	1.1	1.25	1.4	V _{DC}	4
CMOS	Input High Threshold Voltage	V _{IH} (High)	2.7	C	3.3	V _{DC}	5
Interface	Input Low Threshold Voltage	V _{IL} (Low)	0		0.6	V _{DC}	5
Backlight F	Power Consumption	P _{BL}	10:0	35.9	38.1	Watt	
Life time (I	MTTF)		50000			Hour	8, 9

3.1.2 AC Characteristics (Ta = 25 \pm 2 °C)

Parameter		Symbol		Value	Unit	Note	
	raiameter		Min.	Тур.	Max	Offic	NOLE
	Receiver Clock : Spread Spectrum Modulation range	Fclk_ss	Fclk -3%	0	Fclk +3%	MHz	6
LVDS Interface	Receiver Clock : Spread Spectrum Modulation frequency	Fss	30	1	200	KHz	6
	Receiver Data Input Margin Fclk = 85 MHz Fclk = 65 MHz	tRMG	-0.4 -0.5		0.4 0.5	ns	7



3.1.3 Driver Characteristics

Item	Symbol	Min	Max	Unit	condition
Driver Surface Temperature	DST		100	[℃]	Note

Note: Any point on the driver surface must be less than 100°C under any conditions.

3.1.4 TCON Characteristics

Item	Symbol	Min	Max	Unit	condition
TCON Surface Temperature	TST		85	[℃]	Note

Note: Any point on the TCON surface must be less than 85°C under any conditions.

Note:

Test Condition:

(1) $V_{DD} = 12.0V$

(2) Fv = 60Hz

(3) Fclk= Max freq.

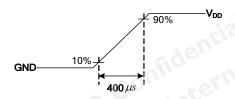
(4) Temperature = 25 °C

(5) Typ. Input current: White Pattern

Max. Input current: Heavy loading pattern defined by AUO

>> refer to "Section:3.3 Signal Timing Specification, Typical timing"

2. Measurement condition: Rising time = 400us



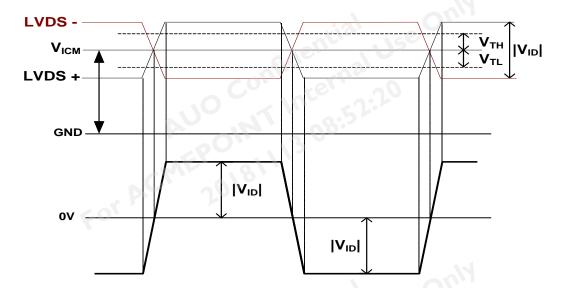
3. Test Condition:

(1) The measure point of V_{RP} is in LCM side after connecting the System Board and LCM.

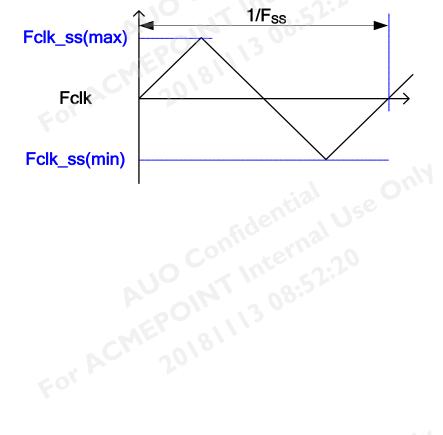
(2) Under Max. Input current spec. condition.

4. V_{ICM} = 1.25V





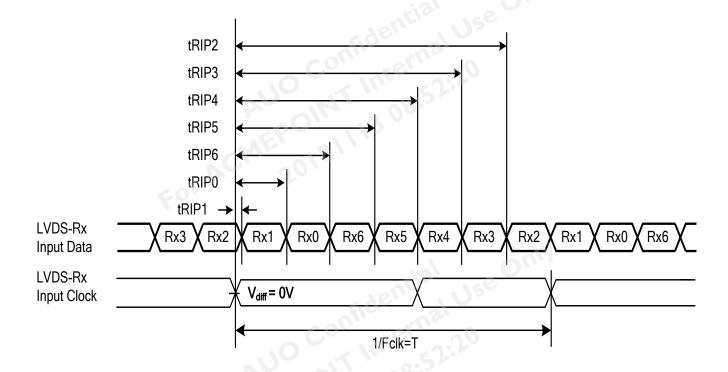
- 5. The measure points of V_{IH} and V_{IL} are in LCM side after connecting the System Board and LCM.
- 6. LVDS Receiver Clock SSCG (Spread spectrum clock generator) is defined as below figures





Receiver Data Input Margin

Parameter	Cumbal	Rating				Note
Parameter	Symbol	Min	Type	Max	Unit	Note
Input Clock Frequency	Fclk	Fclk (min)	rer -	Fclk (max)	MHz	T=1/Fclk
Input Data Position0	tRIP1	- tRMG	0	tRMG	ns	
Input Data Position1	tRIP0	T/7- tRMG	T/7	T/7+ tRMG	ns	
Input Data Position2	tRIP6	2T/7- tRMG	2T/7	2T/7+ tRMG	ns	
Input Data Position3	tRIP5	3T/7- tRMG	3T/7	3T/7+ tRMG	ns	
Input Data Position4	tRIP4	4T/7- tRMG	4T/7	4T/7+ tRMG	ns	
Input Data Position5	tRIP3	5T/7- tRMG	5T/7	5T/7+ tRMG	ns	
Input Data Position6	tRIP2	6T/7- tRMG	6T/7	6T/7+ tRMG	ns	



- The relative humidity must not exceed 80% non-condensing at temperatures of 40℃ or less. At temperatures greater than 40° C, the wet bulb temperature must not exceed 39° C.
- 9. The lifetime (MTTF) is defined as the time which luminance of LED is 50% compared to its original value. ...p/LED on [Operating condition: Continuous operating at Ta = 25±2°C, for single lamp/LED only]



3.2 Interface Connections

LCD connector: FI-RTE51SZ-HF (JAE, LVDS connector) or compatible

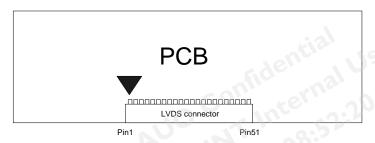
PIN	Symbol	Description
1	N.C.	No connection
2	N.C.	No connection
3	N.C.	No connection
4	N.C.	No connection
5	N.C.	No connection
6	N.C.	No connection
7	LVDS_SEL	Open/High(3.3V) for NS, Low(GND) for JEIDA
8	N.C.	No connection
9	N.C.	No connection
10	N.C.	No connection
11	GND	Ground
12	CH1_Y0-	LVDS Channel 1, Signal 0-
13	CH1_Y0+	LVDS Channel 1, Signal 0+
14	CH1_Y1-	LVDS Channel 1, Signal 1-
15	CH1_Y1+	LVDS Channel 1, Signal 1+
16	CH1_Y2-	LVDS Channel 1, Signal 2-
17	CH1_Y2+	LVDS Channel 1, Signal 2+
18	GND	Ground
19	CH1_CLK-	LVDS Channel 1, Clock -
20	CH1_CLK+	LVDS Channel 1, Clock +
21	GND	Ground
22	CH1_Y3-	LVDS Channel 1, Signal 3-
23	CH1_Y3+	LVDS Channel 1, Signal 3+
24	N.C.	No connection
25	N.C.	No connection
26	GND	Ground
27	GND	Ground
28	CH2_Y0-	LVDS Channel 2, Signal 0-
29	CH2_Y0+	LVDS Channel 2, Signal 0+
30	CH2_Y1-	LVDS Channel 2, Signal 1-
31	CH2_Y1+	LVDS Channel 2, Signal 1+
32	CH2_Y2-	LVDS Channel 2, Signal 2-

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		Nev. U.U
33	CH2_Y2+	LVDS Channel 2, Signal 2+
34	GND	Ground
35	CH2_CLK-	LVDS Channel 2, Clock -
36	CH2_CLK+	LVDS Channel 2, Clock +
37	GND	Ground
38	CH2_Y3-	LVDS Channel 2, Signal 3-
39	CH2_Y3+	LVDS Channel 2, Signal 3+
40	N.C.	No connection
41	N.C.+	No connection
42	N.C.	No connection
43	N.C.	No connection
44	GND	Ground
45	GND	Ground
46	GND	Ground
47	N.C.	No connection
48	V _{DD}	Power Supply, +12V DC Regulated
49	V _{DD}	Power Supply, +12V DC Regulated
50	V _{DD}	Power Supply, +12V DC Regulated
51	V _{DD}	Power Supply, +12V DC Regulated

Note1. Pin number start from the left side as the following figure.



Note2. Please leave N.C. pin unoccupied. It can not be connected by any signal (Low/GND/High).

Note3. Input control signal threshold voltage definition

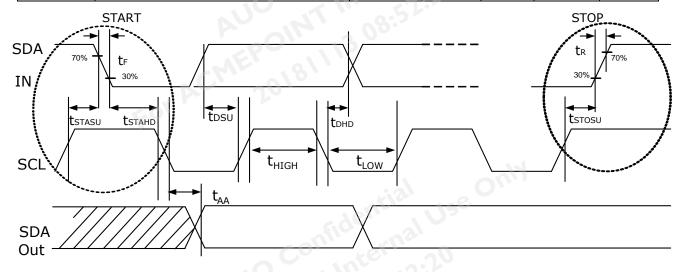
Item	Symbol	Min.	Тур.	Max.	Unit
Input High Threshold Voltage	VIH	2.7	-	3.6	V
Input Low Threshold Voltage	VIL	0	-	0.6	V

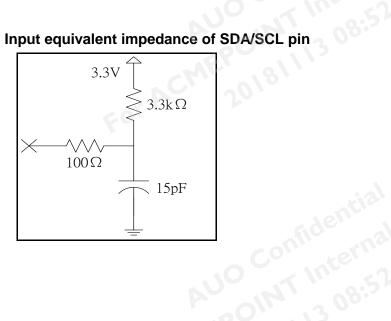


Note4. I2C Data and Clock

I2C Data and Clock timing

	Parameter	Symbol	Min.	Тур.	Max	Unit
	SCL clock frequency	fSCL	_	-	350	kHz
	Clock Pulse Width Low	tLOW	1.85	-	-	us
	Clock Pulse Width High	tHIGH	0.4	-	-	us
	Clock Low to Data Output Valid	tAA	1.76	-	-	us
	Start Setup Time	tSTASU	0.6	-	-	us
I2C	Start Hold Time	tSTAHD	0.6	-	-	us
	Stop Setup Time	tSTOSU	0.6	-	-	us
	Data In Setup Time	tDSU	0.1	$D_{G_{IJ}}$	-	us
	Data In Hold Time	tDHD	00	-	-	us
	SCL/SDA Rise Time	tR	-	-	0.3	us
	SCL/SDA Fall Time	. €tF	20	-	0.3	us





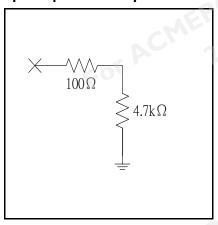


Note5. Write Protection

Mode selection

WP	Note
L or OPEN	Protection
Н	Writable

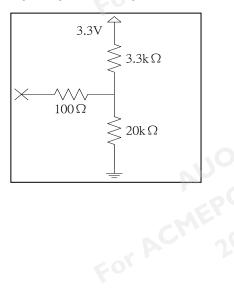
Input equivalent impedance of WP pin



Note6. LVDS data format selection

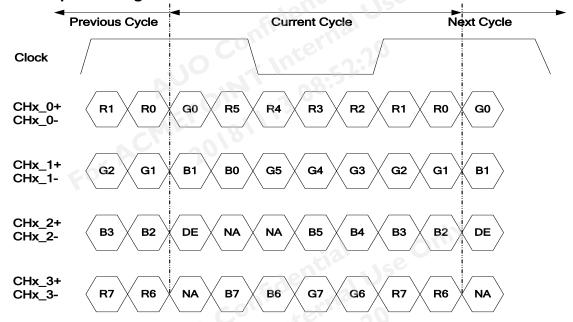
LVDS_SEL	Mode
H or OPEN	NS
L	Jeida

Input equivalent impedance of LVDE_SEL pin



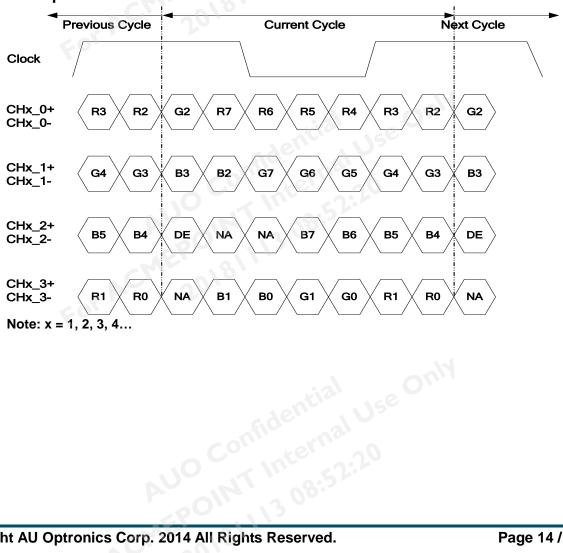


LVDS Option = High/OPEN →NS



Note: x = 1, 2, 3, 4...

LVDS Option = Low → JEIDA





3.3 Signal Timing Specification

This is the signal timing required at the input of the user connector. All of the interface signal timing should be satisfied with the following specifications for its proper operation.

Timing Table (DE only Mode)

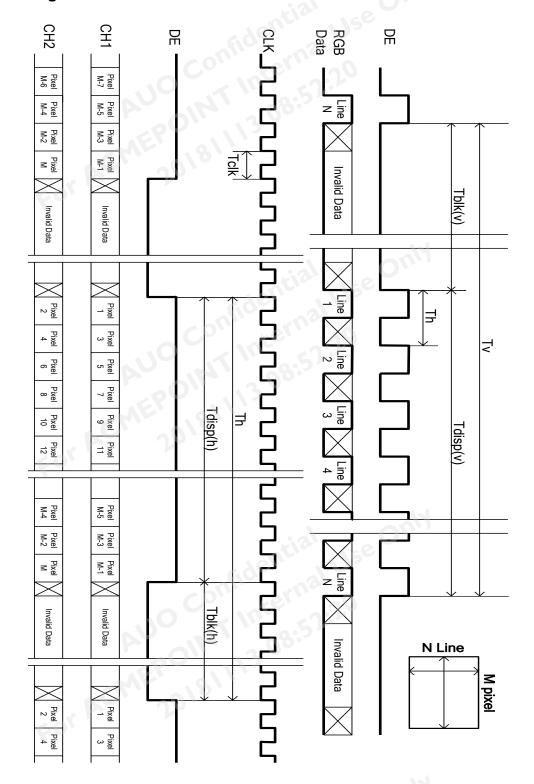
Signal	Item	Symbol	Min.	Тур.	Max	Unit
	Period	Tv	1100	1125	1480	Th
Vertical Section	Active	Tdisp (v)				
	Blanking	Tblk (v)	20	45	400	Th
	Period	Th	1030	1100	1325	Tclk
Horizontal Section	Active	Tdisp (h)				
	Blanking	Tblk (h)	70	140	365	Tclk
Clock	Frequency	Fclk=1/Tclk	53	74.25	82	MHz
Vertical Frequency	Frequency	Fv	47	60	63	Hz
Horizontal Frequency	Frequency	Fh	60	67.5	73	KHz

Notes:

- (1) Display position is specific by the rise of DE signal only.
 Horizontal display position is specified by the rising edge of 1st DCLK after the rise of 1st DE, is displayed on the left edge of the screen.
- (2) Vertical display position is specified by the rise of DE after a "Low" level period equivalent to eight times of horizontal period. The 1st data corresponding to one horizontal line after the rise of 1st DE is displayed at the top line of screen.
- (3)If a period of DE "High" is less than 1920 DCLK or less than 1080 lines, the rest of the screen displays black.
- (4)The display position does not fit to the screen if a period of DE "High" and the effective data period do not synchronize with each other.



3.4 Signal Timing Waveforms





3.5 Color Input Data Reference

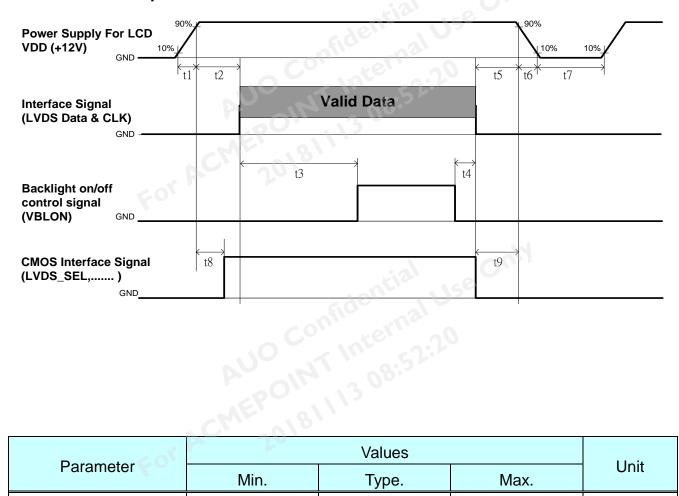
The brightness of each primary color (red, green and blue) is based on the 8 bit gray scale data input for the color; the higher the binary input, the brighter the color. The table below provides a reference for color versus data input.

COLOR DATA REFERENCE

				Input Color Data																					
	Color				RI	ED							GRI	EEN							BL	UE			
	Coloi	MS	В				م	LS	ВВ	MS	В					LS	B	MS	В					LS	3B
			R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	В7	B6	B5	B4	ВЗ	B2	B1	В0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Basic	Blue(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
Color	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
N	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	RED(000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED(001)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R		O																							
	RED(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	RED(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(001)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
G																									
	GREEN(254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	GREEN(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	BLUE(000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	BLUE(001)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
В																									
	BLUE(254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	BLUE(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1



3.6 Power Sequence for LCD



Davamata (60)	A P	Values		Unit	
Parameter Parame	Min.	Type.	Max.	Unit	
t1	0.4		30	ms	
t2	0.1		50	ms	
t3	450	deur U	5	ms	
t4	0*1			ms	
t5	0	~ 10° < 2:2'		ms	
t6	A	03.	*2	ms	
t7	500	1/13		ms	
t8	20*3		50	ms	
t9	0			ms	

Note:

- (1) t4=0: concern for residual pattern before BLU turn off.
- (2) t6: voltage of VDD must decay smoothly after power-off. (customer system decide this value)
- (3) When CMOS Interface signal is N.C. (no connection), opened in Transmitted end, t8 timing spec can be negligible.



3.7 Backlight Specification

	3.7 Backlight Spec	ification											
3.7	3.7 Backlight Specification 3.7.1 Electrical specification (Ta = 25 \pm 2 $^{\circ}$ C)												
	Wass.	0.5	Symbol		1.20	Spec		11	Nete				
	Item	Syn	logi	Condition	Min	Тур	Max	Unit	Note				
1	Input Voltage	VD	DB	13 -	22.8	24	25.2	VDC	-				
2	Input Current	Ι _D	DB	VDDB=24V		1.50	1.59	ADC	1				
3	Input Power	Pc	Родв			36	38.2	W	1				
4	Inrush Current	Irush		VDDB=24V			3.5	ADC	2				
5	On /Off control valtage	V	ON	- VDDB=24V	2	3.3	5.5	VDC	-				
5	On/Off control voltage	V_{BLON}	OFF		0) 9	0.8	0.8		-				
6	On/Off control current	I _{BL}	ON	VDDB=24V	-	-	1.5	mA	-				
_	External PWM) / ED\(\)	MAX	VDDB=24V	2	-	5.5	\/DC	-				
7	Control Voltage	V_EPWM	MIN	VDDB=24V	0	-	0.8	VDC	-				
8	External PWM Control Current	l_EF	PWM	VDDB=24V	-	-	2	mADC	-				
9	External PWM Duty ratio	D_EI	PWM	VDDB=24V	5	-	100	%	3				
10	External PWM Frequency	F_EF	PWM	VDDB=24V	90	180	240	Hz	-				
11	DET status signal	DET	HI	VDDB=24V	Ор	en Colle	ctor	VDC	4				
	DET status signal	DET	Lo	V DDB=24V	-	8.0	0.8	VDC	4				
12	Input Impedance	R	in	VDDB=24V	300			Kohm	-				

Note 1 : Dimming ratio= 100% (MAX) (Ta=25±5°C, Turn on for 45minutes)

Note 2: Measurement condition Rising time = 20ms (VDDB: 10%~90%);

Note 3: Less than 5% dimming control is functional well and no backlight shutdown happened

Note 4: Normal: 0~0.8V; Abnormal: Open collector



3.7.2 Input Pin Assignment

LED driver board connector: Cvilux CI0114M1HRL-NH or equivalent

Pin	Symbol	Description
1	VDDB	Operating Voltage Supply, +24V DC regulated
2	VDDB	Operating Voltage Supply, +24V DC regulated
3	VDDB	Operating Voltage Supply, +24V DC regulated
4	VDDB	Operating Voltage Supply, +24V DC regulated
5	VDDB	Operating Voltage Supply, +24V DC regulated
6	BLGND	Ground and Current Return
7	BLGND	Ground and Current Return
8	BLGND	Ground and Current Return
9	BLGND	Ground and Current Return
10	BLGND	Ground and Current Return
11	DET	BLU status detection: Normal : 0~0.8V ; Abnormal : Open collector (Recommend Pull high R > 10K, VDD = 3.3V)
12	VBLON	BLU On-Off control: High/Open (2~5.5V): BL On; Low (0~0.8V/GND): BL Off
13	NC	NC NC
14	PDIM(*)	External PWM (5%~100% Duty, open for 100%)



PWM Dimming: include Internal and External PWM Dimming

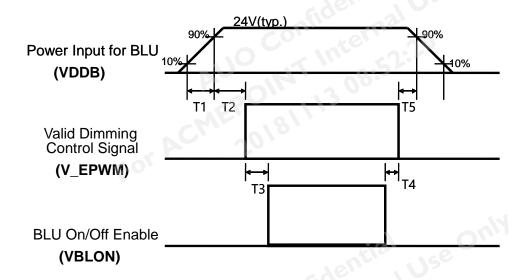
(Note*) IF External PWM function includes 5% dimming ratio. Judge condition as below:

- (1) Backlight module must be lighted ON normally.
- (2) All protection function must work normally.

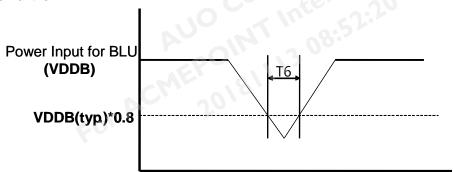
Uniformity and flicker could NOT be guaranteed



3.7.3 Power Sequence for Backlight



Dip condition



D		Value							
Parameter	Min	Тур	Max	Units					
T1	20	On Lex	U	ms					
T2	250	+1000	2:1-	ms					
Т3	200	4 08	.3	ms					
T4	0	143	-	ms					
T5	0	8/,-	-	ms					
T6	30	-	1000	ms ^{*1}					

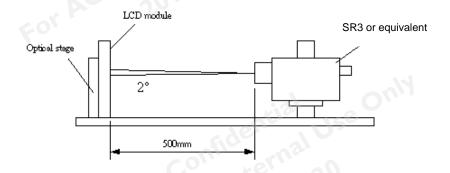
Note:1. T6 describes VDDB dip condition and VDDB couldn't lower than 10% VDDB.



4. Optical Specification

Optical characteristics are determined on the back-light of measured unit is 'ON' and stabilized after 45~60 minutes in a dark environment at 25°C. The values are specified at 50cm distance from the LCD surface at a viewing angle of φ and θ equal to 0°.

Fig.1 presents additional information concerning the measurement equipment and method.



D	0[3]	7, 0	Values		l lmit	Nictor
Parameter	Symbol	Min.	Тур.	Max	Unit	Notes
Contrast Ratio	CR	2400	3000			1
Surface Luminance (White)	L _{WH} (2D)	400	500		cd/m ²	2
Luminance Variation	δwhite(9P)			1.33		3
Response Time (G to G)	Тγ		8	10	ms	4
Color Gamut	NTSC		72	Oull	%	
Color Coordinates		0	115	2		
Red	Rx	RO	0.652			
	R _Y	D)	0.332			
Green	Gx		0.300			
	G _Y	T . 0.00	0.623	T 0 00		
Blue	Bx	Typ0.03	0.150	Typ.+0.03		
NC)	By		0.065			
White	Wx		0.28			
	W _Y	-	0.29			
Viewing Angle				14		5
x axis, right(φ=0°)	Θ_{r}		89	$O_{\overline{U}_{J,1}}$	degree	
x axis, left(φ=180°)	θι	-161	89		degree	
y axis, up(φ=90°)	θυ	Will Co.	89		degree	
y axis, down (φ=270°)	$\theta_{\sf d}$	te	89		degree	



Note:

1. Contrast Ratio (CR) is defined mathematically as:

- 2. Surface luminance is luminance value at point 5 across the LCD surface 50cm from the surface with all pixels displaying white. From more information see FIG 2. LED current I_F = typical value (without driver board), LED input VDDB =24V, I_{DDB}. = Typical value (with driver board), L_{WH}=Lon5 where Lon5 is the luminance with all pixels displaying white at center 5 location.
- 3. The variation in surface luminance, δ WHITE is defined (center of Screen) as: $\delta_{WHITE(9P)} = Maximum(L_{on1}, L_{on2},...,L_{on9}) / Minimum(L_{on1}, L_{on2},...L_{on9})$
- 4. Response time T_{γ} is the average time required for display transition by switching the input signal for five luminance ratio (0%,25%,50%,75%,100% brightness matrix) and is based on F_{ν} =60Hz to optimize.

Me	asured			Target		
Response Time		0%	25%	50%	75%	100%
	0%		0% to 25%	0% to 50%	0% to 75%	0% to 100%
	25%	25% to 0%		25% to 50%	25% to 75%	25% to 100%
Start	50%	50% to 0%	50% to 25%		50% to 75%	50% to 100%
	75%	75% to 0%	75% to 25%	75% to 50%		75% to 100%
	100%	100% to 0%	100% to 25%	100% to 50%	100% to 75%	

 T_{γ} is determined by 10% to 90% brightness difference of rising or falling period. (As illustrated)

The response time is defined as the following figure and shall be measured by switching the input signal for "any level of gray(bright)" and "any level of gray(dark)".

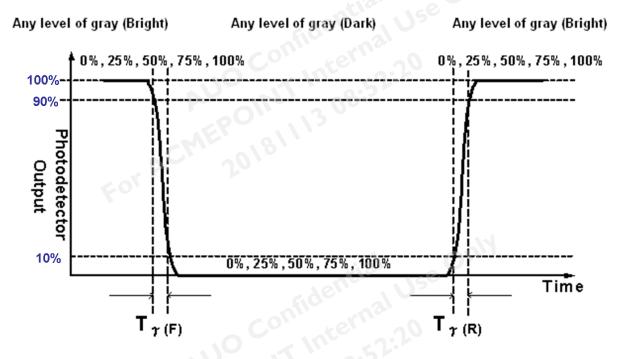
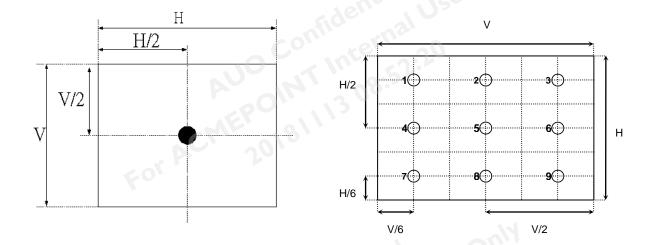
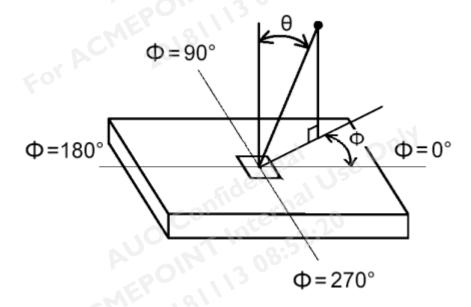




FIG. 2 Luminance



5. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG3.





5. Mechanical Characteristics

The contents provide general mechanical characteristics for the model P320HVN02.0 In addition the figures in the next page are detailed mechanical drawing of the LCD.

ı	tem	Dimension	Unit	Note
Outline Dimension	Horizontal	719.2	mm	
	Vertical	413.7	mm	
	Depth (Dmin)	10.8	mm	front bezel to back bezel
	Depth (Dmax)	24.8	Jse mm	to wall mount
Weight	4591		G G	w/ DB

5.1 Placement Suggestions

 Landscape Mode: The default placement is T-Con Side on the lower side and the image is shown upright via viewing from the front.





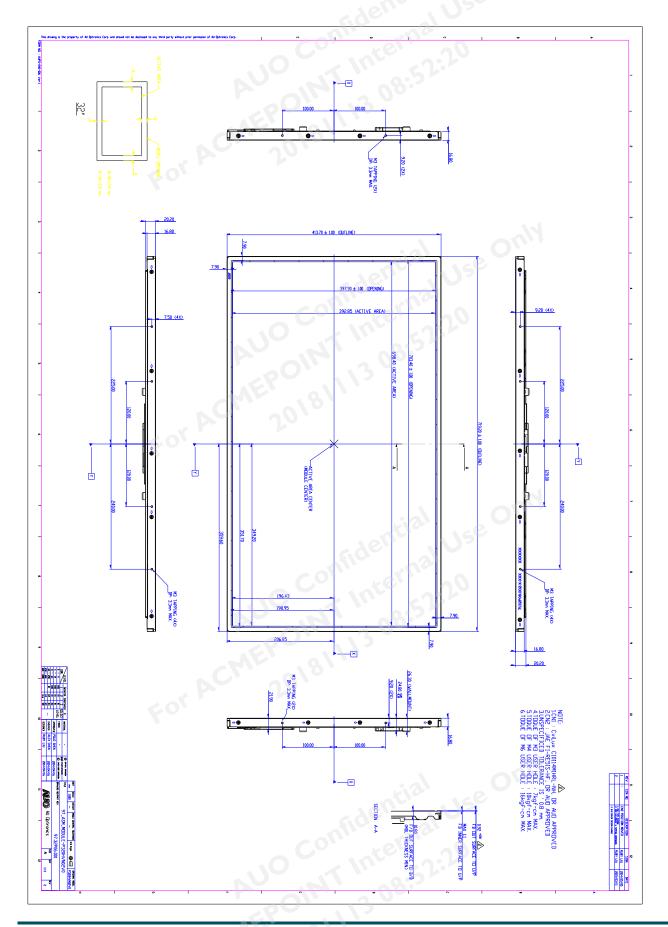
2. Portrait Mode: The default placement is that T-Con side has to be placed on the left side via viewing from the front.

(Front view)



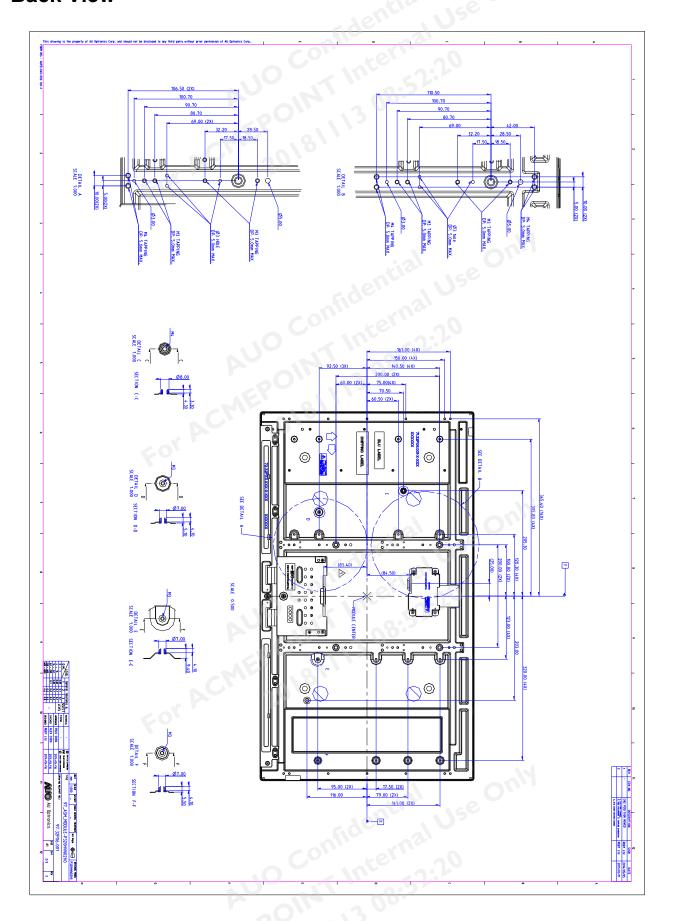


Front View

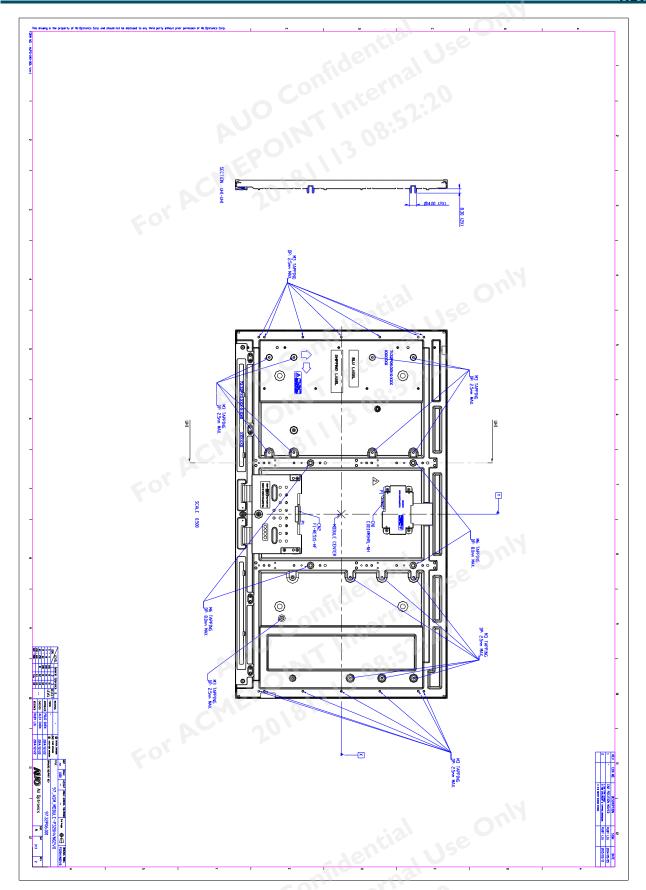




Back View









6. Reliability Test Items

	Test Item	Q'ty	Condition
1	High temperature storage test	3	60°С, 300hrs
2	Low temperature storage test	3	-20°С, 300hrs
3	High temperature operation test	3	50°С, 300hrs
4	Low temperature operation test	3	-5°С, 300hrs
5	Vibration test (non-operation)	3 Confid	Wave form: random Vibration level: 1.0G RMS Bandwidth: 10-300Hz Duration: X axis, Vertical, 10min Y axis, Vertical, 10min Z axis, Vertical, 10min one time each direction
6	Shock test (non-operation)	3	Shock level 50G ,20ms ±X,Y,Z axis Waveform: half sine wave Direction: One time each direction
7	Vibration test (With carton)	1CTN/7PCS	Random wave (1.04Grms 2~200Hz) Duration: X,Y,Z 20min per axes
8	Drop test (With carton)		Height: 30.5 cm (ASTMD4169-I) 1 corner, 3 edges, 6 surfaces (refer ASTM D 5276)



7. International Standard

7.1 Safety

- (1) UL 60950-1; Standard for Safety of Information Technology Equipment Including electrical Business Equipment.
- (2) IEC 60950-1; Standard for Safety of International Electrotechnical Commission
- (3) EN 60950-1; European Committee for Electrotechnical Standardization (CENELEC), EUROPEAN STANDARD for Safety of Information Technology Equipment Including Electrical Business Equipment.

7.2 EMC

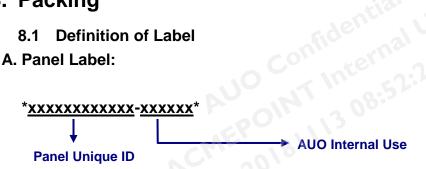
- (1) ANSI C63.4 "Methods of Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electrical Equipment in the Range of 9kHz to 40GHz. "American National standards Institute(ANSI), 1992
- (2) C.I.S.P.R "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." International Special committee on Radio Interference.
- (3) EN 55022 "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." European Committee for Electrotechnical Standardization. (CENELEC), 1998

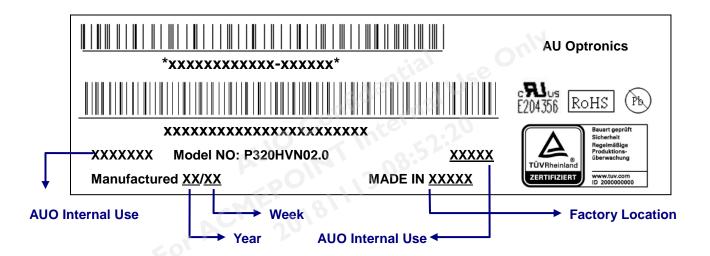


8. Packing

8.1 Definition of Label

A. Panel Label:





Green mark description

- (1) For Pb Free Product, AUO will add (Pb) for identification.
- (2) For RoHs compatible products, AUO will add RoHS for identification.

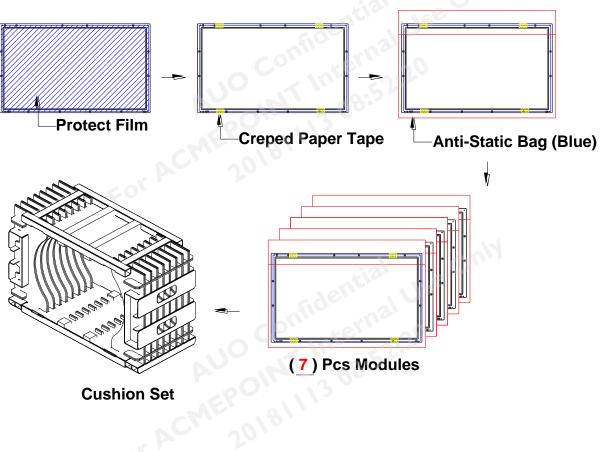
Note: The green Mark will be present only when the green documents have been ready by AUO internal green team. (definition of green design follows the AUO green design checklist.)

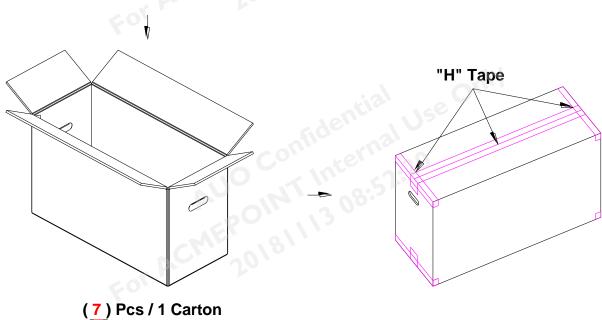
B. Carton Label:





8.2 Packing Methods

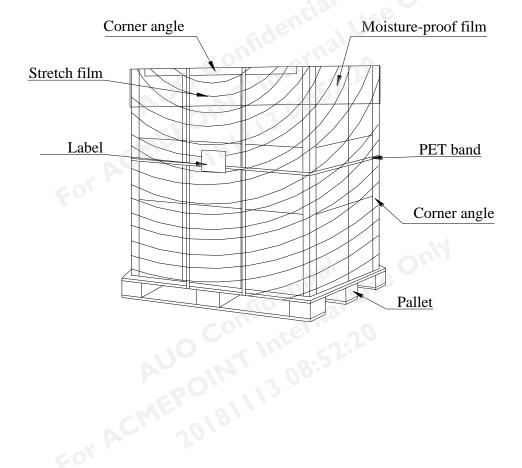






8.3 Pallet and Shipment Information

			Packing		
	Item	Qty.	Dimension	Weight (kg)	Remark
1	Packing Box	7pcs/box	820(L)*376(W)*535(H)	39.47	
2	Pallet	1	1150(L)*840(W)*132(H)	15.6	
3	Boxes per Pallet	CZV			
4	Panels per Pallet	at De			
5	Pallet after packing	42	1150(L)*840(W)*1202(H)	252.42	





9. Precautions

Please pay attention to the followings when you use this TFT LCD module.

9.1 Mounting Precautions

- (1) You must mount a module using holes arranged in four corners or four sides.
- (2) You should consider the mounting structure so that uneven force (ex. twisted stress) is not applied to module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer.

 Transparent protective plate should have sufficient strength in order to the resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter cause circuit broken by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizer with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth. (Some cosmetics are detrimental to the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front/ rear polarizer. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.

9.2 Operating Precautions

- (1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage: V=±200mV(Over and under shoot voltage)
- (2) Response time depends on the temperature. (In lower temperature, it becomes longer.)
- (3) Brightness depends on the temperature. (In lower temperature, it may become lower.) And in lower temperature, response time (required time that brightness is stable after turned on) becomes longer.
- (4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (6) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interface.
- (7) The conductive material and signal cables are kept away from LED driver inductor to prevent abnormal display, sound noise and temperature rising.



9.3 Operating Condition for Public Information Display

The device listed in the product specification is designed and manufactured for PID (Public Information Display) application. To optimize module's lifetime and function, below operating usages are required.

- (1) Normal operating condition
 - A. Operating temperature: 0~50°C
 - B. Operating humidity: 10~90%
 - C. Display pattern: dynamic pattern (Real display).Note) Long-term static display would cause image sticking.
- (2) Operation usage to protect against abnormal display due to long-term static display.
 - A. Suitable operating time: under 24 hours a day or less.
 - B. Liquid Crystal refresh time is required. Cycling display between 5 minutes' information (static) display and 10 seconds' moving image.
 - C. Periodically change background and character (image) color.
 - D. Avoid combination of background and character with large different luminance.
- (3) Periodically adopt one of the following actions after long time display.
 - A. Running the screen saver (motion picture or black pattern)
 - B. Power off the system for a while
- (4) LCD system is required to place in well-ventilated environment. Adapting active cooling system is highly recommended.
- (5) Product reliability and functions are only guaranteed when the product is used under right operation usages. If product will be used in extreme conditions, such as high temperature/ humidity, display stationary patterns, or long operation time etc..., it is strongly recommended to contact AUO for filed application engineering advice. Otherwise, its reliability and function may not be guaranteed. Extreme conditions are commonly found at airports, transit stations, banks, stock market and controlling systems.

9.4 Electrostatic Discharge Control

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wristband etc. And don't touch interface pin directly.

9.5 Precautions for Strong Light Exposure

- 1. Strong light exposure causes degradation of polarizer and color filter.
- 2. To keep display function well as a digital signage application, especially the component of TFT is very sensitive to sunlight, it is necessary to set up blocking device protecting panel from radiation of ambient environment.



9.6 Storage

When storing modules as spares for a long time, the following precautions are necessary.

- (1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
- (2) The polarizer surface should not come in contact with any other object. It is recommended that they be stored in the container in which they were shipped.
- (3) Storage condition is guaranteed under packing conditions.
- (4) The phase transition of Liquid Crystal in the condition of the low or high storage temperature will be recovered when the LCD module returns to the normal condition.

9.7 Handling Precautions for Protection Film

- (1) The protection film is attached to the bezel with a small masking tape. When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
- (2) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the bezel after the protection film is peeled off.
- (3) You can remove the glue easily. When the glue remains on the bezel or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.